

PRELIMINARY DATASHEETS

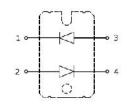
Anti-Parallel 1200 2X30A Fast Recovery Epitaxial Diode in Isolated SOT227 package

APPLICATIONS

- > Switch mode power supplies (SMPS) rectifiers
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders
- > Inductive heating and melting
- > Ultrasonic cleaners and welders
- Power factor correction (PFC) circuits
- Inversion welder
- Converter and chopper

FEATURES

- > Ultrafast recovery time
- Soft recovery characteristics
- Low recovery loss
- Low forward voltage
- > High surge current capability
- Low leakage current
- Pb free finished; RoHS compliant





MAXIMUM RATINGS (per Diode)

Parameter	Symbol	Value	Units	
Repetitive peak reverse voltage	V _{RRM}	1200	٧	
Continuous forward current T _C = 85°C	I _F	30		
Surge non-repetitive forward current T_J = 45°C, t_P = 10 ms, 50Hz, Sine	IFSM	300	A	
Operating junction and storage temperature	Tj, Tstg	-40 +150	°C	

Thermal and Isolation Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
Thermal resistance, junction to case, per Diode	R _{thJC}	1.43	°C/W
Isolation voltage, RMS (measured between terminals and mounting base, 50-60 Hz, for 1-3 seconds)	V _{iso}	3000	٧



Electrical Characteristics (per Diode), at T_j = 25°C, unless otherwise specified

Parameter	Symbol	Value			II mil
		Min.	Тур.	Max.	Unit
Static Characteristics					
Reverse leakage current $V_R = 1200 \text{ V}$, $T_J = 25 \text{ °C}$	I _R	-	-	100	μΑ
Forward voltage drop I _F = 30A, T _j = 25 °C I _F = 30A, T _j = 125 °C	V _F		2.0 1.6	2.5	V

Electrical Characteristics (per Diode), at T_j = 25°C, unless otherwise specified

Parameter	Sala al	Value			119
	Symbol	Min.	Тур.	Max.	Unit
Dynamic Characteristics					
Reverse recovery time					
$V_R = 30V$, $I_F = 1A$, $di_F/dt = -200A/\mu s$	4	-	33	-	ns
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 25 \circ C$	† _{rr}	-	244	-	
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 125$ °C		-	444	-	
Maximum reverse recovery current					
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 25 \circ C$	I _{rrm}	-	9.1	-	Α
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 125$ °C		-	16.6	-	
Reverse recovery charge					
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_i = 25 \circ C$	Qrr	-	758	-	nC
$V_R = 600V$, $I_F = 30A$, $di_F/dt = -200A/\mu s$, $T_j = 125$ °C			4065	-	

Figure 1 – Forward voltage drop vs forward current

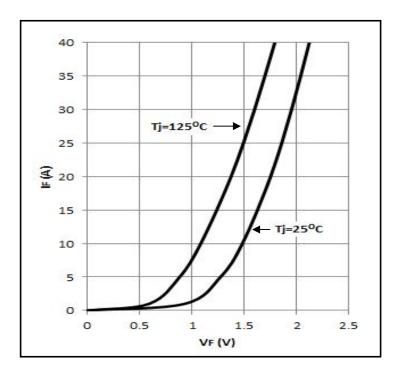
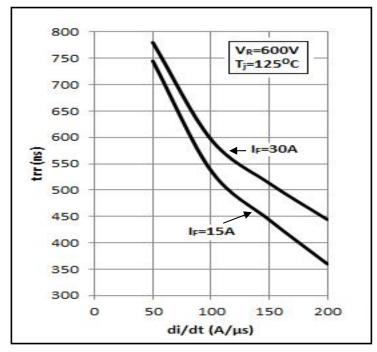


Figure 2 – Reverse recovery time vs di_F/dt



Website: www.iqxprzpower.com

Telefax +632 837 1538



Figure 3 – Reverse recovery charge vs di_F/dt

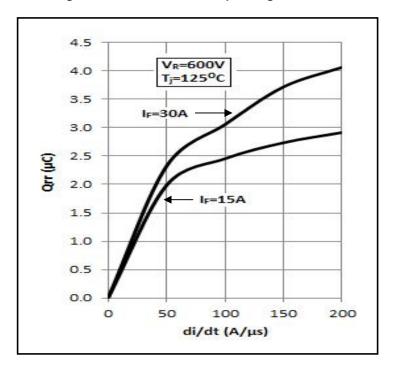


Figure 4 - Reverse recovery current vs di_F/dt

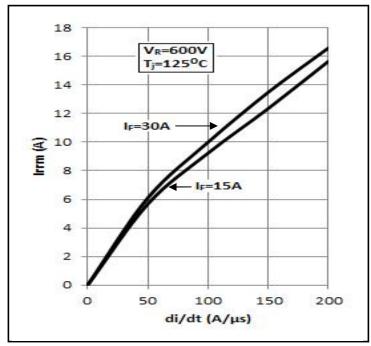
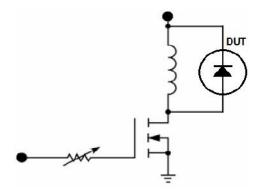
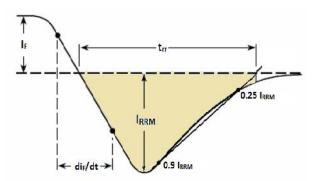


Figure 5 – Diode Reverse Recovery Test Circuit and Waveform



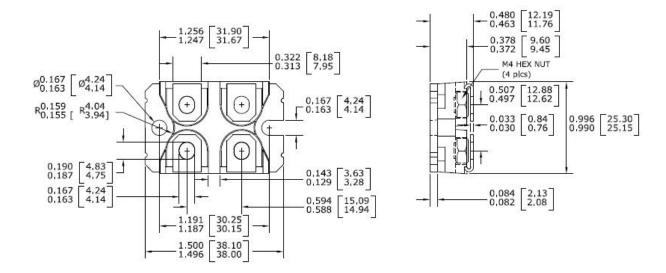


Website: <u>www.iqxprzpower.com</u>

Telefax +632 837 1538



Package Outline Drawing



Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**

Website: www.iqxprzpower.com

Telefax +632 837 1538